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RESIN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yew
Serial No: 10/612,129
Filed: 7/2/2003
For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC
SUBSTRATE

Docket No: TI-26239.1
Examiner: Cao, Phat X.
Art Unit: 2814

RESPONSE UNDER 37 C.F.R. § 1.116

Assistant Commissioner For Patents
Washington, DC 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being
transmitted by facsimile to the U.S. Patent and Trademark
Office at 703-872-9308 on 10-21-04.

Jamie Chambers
Jamie Chambers

Dear Sir:

Responsive to the Office Action mailed August 6, 2004 in connection with the
above identified application, Applicants respectfully submit the following remarks.